

Chief Guests

Dr. A. Govardhan, Rector, JNTUH

Dr. K. Vijaya Kumar Reddy, Director, DRD, JNTUH

International Advisory Committee

Dr. Hao Hong, Curtin University, Perth, Australia

Dr. Megat Mohammad Hamdan bin Megat Ahmad,

National Defense University, Malaysia

Dr. N. Venkat Reddy, IIT, Hyderabad, India

Dr. R. Jose Immanuel, IIT, Bhilai, India

Dr. Sumitra Sharma, NIT Silchar, India

National Advisory Committee

Dr. B. Kiran, Prof of Mech Engg, IIT, Tirupati

Dr. C. S. P. Rao, Director, NIT, AP

Dr. M. Sreenivasa Rao, Professor of Mechanical -
JNTU-Hyderabad.

Dr. Hari V Rao, Director, DRDL, Hyderabad

Dr. Ankur Jaiswal, Manipal Institute of Technology,
Manipal, India

Dr. A. P. Patil, National Institute of Technology,
Nagpur, India

Dr. Jagesvar Verma, NIFFT, Ranchi, India

Advisor

Sri. Ch. Malla Reddy, Minister, Labour &
Employment, Factories, Telangana State

Chief Patrons

Sri. M. Laxman Reddy, Chairman

Sri. G. Narasimha Yadav, Treasurer

Sri. Ch. Mahender Reddy, Secretary & Correspondent

Sri. G. Chandra Sekhar Yadav, Executive Director

Sri. M. Rajasekhar Reddy, Director

Sri. G. Jai Kishan Yadav, Director

Sri. G. Raja Shekar Yadav, Director

Patron & Program Chair

Dr. P. Santosh Kumar Patra, Principal.



Convener

Dr. D.V. Sreekanth, Professor & HOD, MECH

Coordinators

Mr. B. Ashok Kumar, Assistant Professor

Dr. M. Lavanya, Assistant Professor

Co-Coordinator

Dr Ch. Jayaramulu, Professor

Dr. B. Ravi Naik, Associate Professor

Ms. K. Sunitha, Assistant Professor

Mr. R. Suvarna Babu, Assistant Professor

Mr. T. Paramesh, Associate Professor

Mr. Y Chandra Sekhar Yadav, Assistant Professor

Mr. Hanuma Naik, Assistant Professor

Ms. K. Archana, Assistant Professor

Ms. K. Hemalatha, Assistant Professor

About the College

St. Martin's Engineering College, an Autonomous Institution, situated in an eco-friendly environment, with state of art infrastructure. College has achieved the prestigious grade A+ from NAAC, UGC Paramarsh mentor, NBA accredited, ISO certified, DSIR Recognition, Remote center of IIT Bombay, Member of CII and MSME certified Institution. Signed more than 82 MoU's with major companies' and institutions. Careers 360 Certified as AA+; Competition Success Review Ranked 3 out of 20; Career Connect Ranked 13 'Best Engineering Colleges of India and Wikipedia Ranked 8th in Telangana. The college is best owed with the glorious Governor Award twice; The Engineering Educators' Award 2019; NIRDPR Award (Govt. of India); IDF Best Partner Award; Dewang Mehta Award; TCSION Award; CSI Award (Students Chapter); Best Innovation by Federation of Gujarat Industries and Street Cause-Most Dedicated Division. Best Sports College by Stumagz, Telangana, - National Leadership Excellence Award- 2019 by ICCI.



International Conference on “Advanced Materials & Processes for Engineering Applications”



ELSEVIER

(ICAMP)

www.icamp.info

08th - 09th July 2022

ScienceDirect



Organized by

Department of Mechanical Engineering

St. Martin's Engineering College

An Autonomous Institute

A Non-Minority College | Approved by AICTE | Affiliated to
JNTUH, Hyderabad | NAAC-Accredited 'A+' Grade | 2(f)
& 12(B) status (UGC) ISO 9001:2015 Certified | NBA
Accredited | SIRO (DSIR) | UGC-Paramarsh |
Recognized Remote Center of IIT, Bombay

Dhulapally, Secunderabad - 500100,
Telangana state, India

www.smeac.ac.in

About Conference

ICAMP aims to provide common platform to all the leading academic scientists, academicians and research scholars to exchange and share their experiences and research ideas in the advanced and latest trends in engineering and technologies in materials applicable for manufacturing, Robotics and other new trends in Engineering. This conference mainly provides a premier interdisciplinary platform for the researchers, educators, and practitioners to present and discuss their authentic and innovative ideas, trends and concerns as well as challenges encountered, and solutions adopted in the advanced fields of engineering and technology.

Scope of conference

The ICAMP aims to bring together leading academic scientists, researchers, industrial personnel, and research scholars from all over the world under a roof to exchange and share their experiences and research results through brainstorming sessions on current trends and latest innovations covering all aspects of Engineering. The conference will have keynote address from illustrious speakers and peer-reviewed high quality technical paper presentations. The main objective of the conference is to build the network of engineering experts of respective research area and to increase the awareness of new trends happening in their field of interest. It provides a platform at the international level to present the innovative ideas and approaches in design, analysis, and development in various topics of Mechanical Engineering disciplines

Note: The authors of the registered paper will be issued Certificate from the conference organizers

Registration Fee:

| | |
|--|--------------|
| Faculty / Research Scholars / Students | : Rs 8000/- |
| Delegates from Industry | : Rs 10000/- |
| Foreign Delegates | : \$ 150 |

Important Dates:

| | |
|----------------------------|--------------|
| Abstract Submission | : 08-05-2022 |
| Full paper submission | : 29-05-2022 |
| Intimation to Candidates | : 30-05-2022 |
| Last Date for Registration | : 10-06-2022 |

Send your full papers only in .doc/.docx format to:
icamp2022@smec.ac.in

Note: While submitting the final papers please mention the Title & Paper ID in the subject line

Organizing Committee

Dr. S.V. S Raju, Dean Academics
Dr. Sanjay Kumar Suman, Dean R&D
Dr. N. Rama Chandra, HOD, EEE
Dr. D. Ranadheer Reddy, HOD, H&S
Dr. M. Narayanan, HOD, CSE
Dr. T. Poongothai, HOD, CSE (AI & ML)
Dr. A. Anand, HOD, ECE
Dr. R. Nagaraju, HOD, IT
Mrs. Sandhya Kiran JK, HOD, CE
Dr. N. Krishnaiah, HOD, AI & ML
Dr. R. Santosh Kumar, HOD, AI & DS
Dr. G. Govinda Rajulu, HOD, CSD
Dr. N Satheesh, HOD, M.Tech (AI & DS)

Contact us

Dr M Lavanya, Asst Professor
Mob: **8095368918**
Mr. B. Ashok Kumar, Assistant Professor
Mob: **9966805414**

Mail:

icamp2022@smec.ac.in

The template for submissions can be found [here](https://www.materialstoday.com/proceedings-template).
(<https://www.materialstoday.com/proceedings-template>)

Conference Topics

Perspective authors are invited to submit their unpublished significant research work to the ICAMP.

Topics of interest but not limited to:

- Advance Design and Manufacturing
- Processes
- Industrial Engineering
- Thermal and Automobile Engineering
- Robotics
- Surface Engineering and Modifications
- Coatings
- Materials Science and Engineering
- Ceramics and Composite Materials

Note: The call for papers is not restricted to the above-mentioned list.

PUBLICATION

Papers will be published in **Elsevier Proceedings**



materialstoday:
PROCEEDINGS



**St. Martin's
Engineering College**

An Autonomous Institution
Dhulapally, Kompally,
Secunderabad-500100, Telangana, India
www.smeac.ac.in



**International Conference on
“Advanced Materials & Processes for
Engineering Applications”**



(ICAMP)



08th - 09th July 2022

Registration Form

Name:

Designation:

Department:

College / Industry

Address for Communication:
.....
.....
.....

Pin Code: State:

Phone:

E-Mail ID:

Transaction Id:

Date of Transaction:

Signature of the Candidate

(Filled scan copy of Registration form to be submitted after receiving accepted letter and doing the payment)

Payment Details: Online transaction only

Account Details: (Current Account)

PRINCIPAL,

St. Martin's Engineering College

Bank Name: SBI, Kukatpally,
Hyderabad

Account No: 30667640268

IFSC code: SBIN0011664

